MOSFET - N-Channel Shielded Gate PowerTrench®

150 V, 7.3 mΩ, 101 A

NTP7D3N15MC

Features

- Shielded Gate MOSFET Technology
- Max $R_{DS(on)} = 7.3 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 62 \text{ A}$
- 50% Lower Qrr than other MOSFET Suppliers
- Lowers Switching Noise/EMI
- 100% UIL Tested
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parar	Symbol	Value	Unit		
Drain-to-Source Voltag	V_{DSS}	150	V		
Gate-to-Source Voltage	9	_	V _{GS}	±20	V
Continuous Drain Current R _{θJC} (Note 2)	Steady State T _C = 25°C		I _D	101	Α
Power Dissipation $R_{\theta JC}$ (Note 2)	State	_	P _D	166	W
Continuous Drain Current R _{θJA} (Notes 1, 2)	Steady State T _A = 25°C		I _D	12.1	Α
Power Dissipation R _{θJA} (Notes 1, 2)	State		P _D	2.4	W
Pulsed Drain Current	T _C = 25°	°C, t _p = 100 μs	I _{DM}	574	Α
Operating Junction and Range	T _J , T _{stg}	-55 to +175	°C		
Single Pulse Drain-to-S Energy (I _L = 20 A _{pk} , L =	E _{AS}	600	mJ		
Lead Temperature for S (1/8" from case for 10 s)	TL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

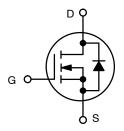
- 1. Surface-mounted on FR4 board using a 1 in², 2 oz. Cu pad.
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.



ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
150 V	7.3 mΩ @ 10 V	101 A



N-CHANNEL MOSFET

MARKING

TO-220 CASE 221A TO-3 Source

NTP7D3N15MC = Specific Device Code

A = Assembly Location

Y = Year
WW = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NTP7D3N15MC	TO-220 (Pb-Free)	800 / Tube

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{ hetaJC}$	0.9	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{ hetaJA}$	62.5	

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified)

Parameter	Symbol	Test Condit	tion	Min	Тур	Max	Unit
OFF CHARACTERISTICS					•	•	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		150			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /	I _D = 250 μA, ref to 25°C			71		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 120 V	T _J = 25°C			1.0	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	= ±20 V			±100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$: 342 μA	2.5		4.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = 342 μA, ref	to 25°C		-7.3		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D	= 62 A		6.2	7.3	
		V _{GS} = 8 V, I _D	= 31 A		6.6	8.4	mΩ
Forward Transconductance	9FS	V_{DS} = 10 V, I_{D}	= 62 A		119		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE					•	
Input Capacitance	C _{ISS}			4250			
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MHz		1250		pF	
Reverse Transfer Capacitance	C _{RSS}			15			
Gate-Resistance	R_{G}				0.8	1.6	Ω
Total Gate Charge	Q _{G(TOT)}			53		nC	
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 75 V; I _D = 62 A			14		
Gate-to-Source Charge	Q _{GS}				23		
Gate-to-Drain Charge	Q_{GD}				8.5		
Plateau Voltage	V _{GP}				5.8		V
Output Charge	Q _{OSS}	V _{DD} = 75 V, V _{GS} = 0 V			133		nC
SWITCHING CHARACTERISTICS (Note 3)						•	•
Turn-On Delay Time	t _{d(ON)}				27		
Rise Time	t _r	VGS = 10 V. VDF	s = 75 V.		8.5		
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 10 V, V_{DD} = 75 V, I_{D} = 62 A, R_{G} = 4.7 Ω			33		ns
Fall Time	t _f			5.8			
DRAIN-SOURCE DIODE CHARACTERISTIC	s						
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V, I _S = 62 A	T _J = 25°C		0.93	1.2	V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, V _{DD}	= 75 V		55		ns
Reverse Recovery Charge	Q _{RR}	dl _S /dt = 300 A/μs, l _S = 62 A			247		nC
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, V _{DD} = 75 V			50		ns
Reverse Recovery Charge	Q _{RR}	$V_{GS} = 0 \text{ V}, V_{DD} = 73 \text{ V}$ $dI_{S}/dt = 1000 \text{ A}/\mu\text{s}, I_{S} = 62 \text{ A}$			720		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

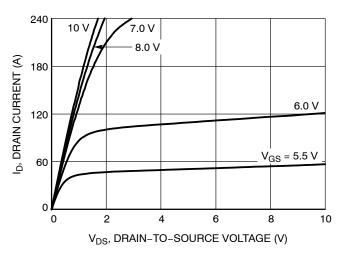


Figure 1. On-Region Characteristics

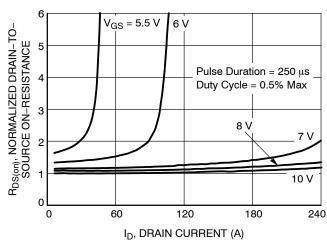


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

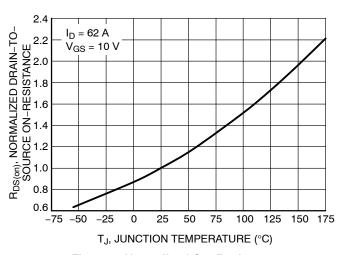


Figure 3. Normalized On–Resistance vs. Junction Temperature

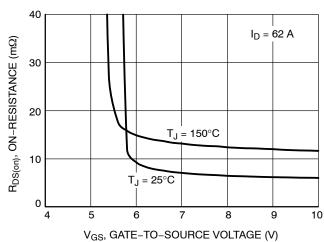


Figure 4. On-Resistance vs. Gate-to-Source Voltage

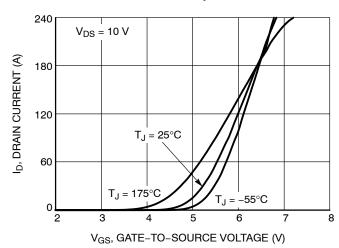


Figure 5. Transfer Characteristics

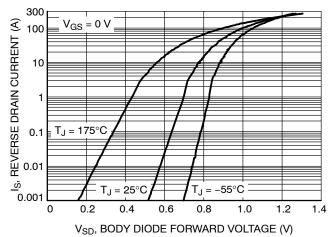


Figure 6. Source-to-Drain Diode Forward Voltage vs. Source Current

TYPICAL CHARACTERISTICS

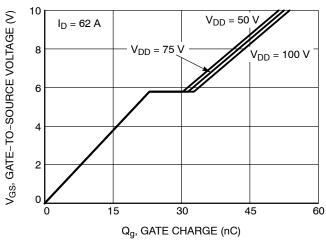


Figure 7. Gate Charge Characteristics

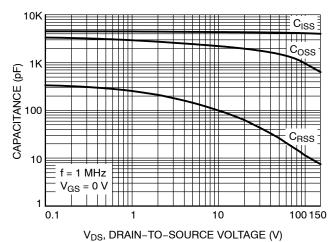


Figure 8. Capacitance vs. Drain-to-Source Voltage

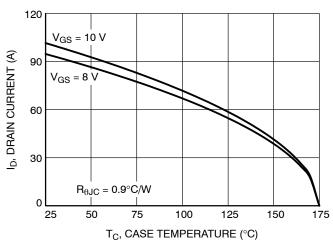


Figure 9. Drain Current vs. Case Temperature

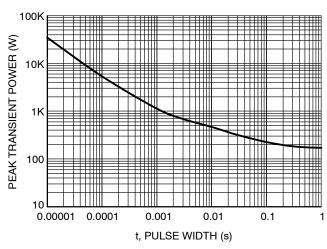


Figure 10. Peak Power

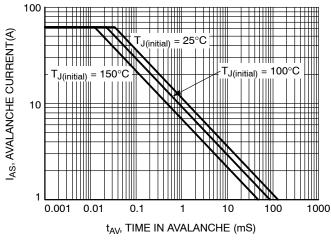


Figure 11. Unclamped Inductive Switching Capability

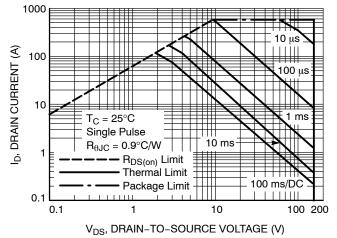


Figure 12. Forward Bias Safe Operating Area

TYPICAL CHARACTERISTICS

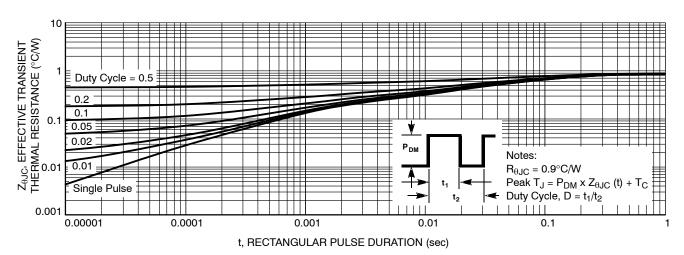
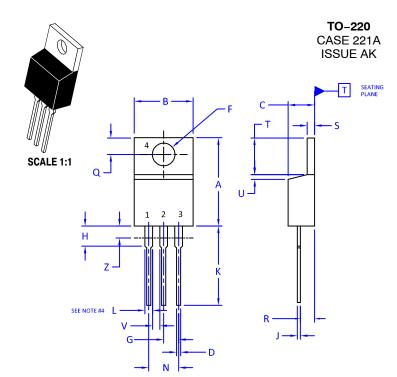


Figure 13. Transient Thermal Impedance





DATE 13 JAN 2022

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCHES		MILLIMI	ETERS
DIM	MIN.	MAX.	MIN.	MAX.
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.60	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
К	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.41
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

STYLE 1: PIN 1. 2. 3. 4.	COLLECTOR EMITTER	STYLE 2: PIN 1. 2. 3. 4.	COLLECTOR	STYLE 3: PIN 1. 2. 3. 4.	ANODE	2. 3.	MAIN TERMINAL 1 MAIN TERMINAL 2 GATE MAIN TERMINAL 2
STYLE 5: PIN 1. 2. 3. 4.	DRAIN SOURCE	2. 3.	ANODE CATHODE ANODE CATHODE	STYLE 7: PIN 1. 2. 3. 4.	ANODE	2. 3.	CATHODE ANODE EXTERNAL TRIP/DELAY ANODE
STYLE 9: PIN 1. 2. 3. 4.		STYLE 10: PIN 1. 2. 3. 4.	GATE	STYLE 11: PIN 1. 2. 3. 4.	DRAIN	STYLE 12: PIN 1. 2. 3. 4.	

DOCUMENT NUMBER:	98ASB42148B	Electronic versions are uncontrolled except when accessed directly from the Document Repos Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	TO-220		PAGE 1 OF 1	

onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales